TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

2SK2949

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain–source ON resistance : $R_{DS (ON)} = 0.4 \Omega (typ.)$ • High forward transfer admittance : $|Y_{fs}| = 8.0 S (typ.)$ • Low leakage current : $I_{DSS} = 100 \mu A (max) (V_{DS} = 400 V)$

• Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	400	(y)
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	400	$\langle \langle v \rangle \rangle$
Gate-source voltage		V_{GSS}	±30	\ \ \
Drain current	DC (Note 1)	I _D	10	A
	Pulse (Note 1)	I _{DP}	40	A
Drain power dissipation	n (Tc = 25°C)	P_{D}	80	W
Single pulse avalanche	e energy (Note 2)	E _{AS}	360	mJ
Avalanche current		IAR	10	A
Repetitive avalanche energy (Note 3)		EAR)) 8	mJ
Channel temperature		T _{ch}	150	∕ °C
Storage temperature range		T _{stg}	-55 to 150	∑%c

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba-Semiconductor Reliability Handbook ("Handling Precautions") Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

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Characteristics	\$ymbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.56	°C / W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.3	°C/W

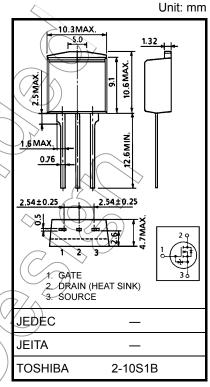
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 5.85 mH, R_G = 25 Ω , I_{AR} = 10 A

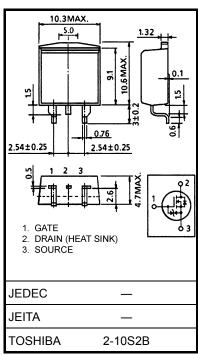
Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.



Weight: 1.5 g (typ.)



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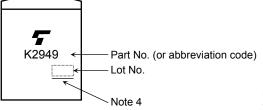
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cui	rrent	I _{DSS}	V _{DS} = 400 V, V _{GS} = 0 V	//	_	100	μA
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	400	_	_	V
Gate threshold v	voltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) >-	4.0	V
Drain-source Ol	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 5.0 A	<u> </u>	0.4	0.55	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 5.0 A	4.0	8.0	_	S
Input capacitano	e	C _{iss}		_	1340	_	
Reverse transfer	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	160	_	pF
Output capacitar	nce	Coss		_	490	_	
Switching time F	Rise time	t _r	$V_{GS}^{10 \text{ V}} \prod V_{OUT}^{ID} = 5 \text{ A}$	- (22	<u>></u>	
	Turn-on time	t _{on}	$\begin{array}{c c} \text{VOUT} \\ \text{RL} = \\ \text{40} \ \Omega \end{array}$		60) _	20
	Fall time	t _f	$V_{DD} = 200 \text{ V}$		32	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$) –	140	_	
Total gate charg plus gate-drain)		Qg		-	34	_	
Gate-source cha	arge	Q _{gs}	$V_{DD} \approx 320 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	_	18	_	nC
Gate-drain ("mil	ler") Charge	Qgd	<u> </u>	_	16	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	10	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	40	Α
Forward voltage (diøde)	V _{DSF}	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V	_	350	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} / dt = 100 A / μs	_	2.6	_	μC





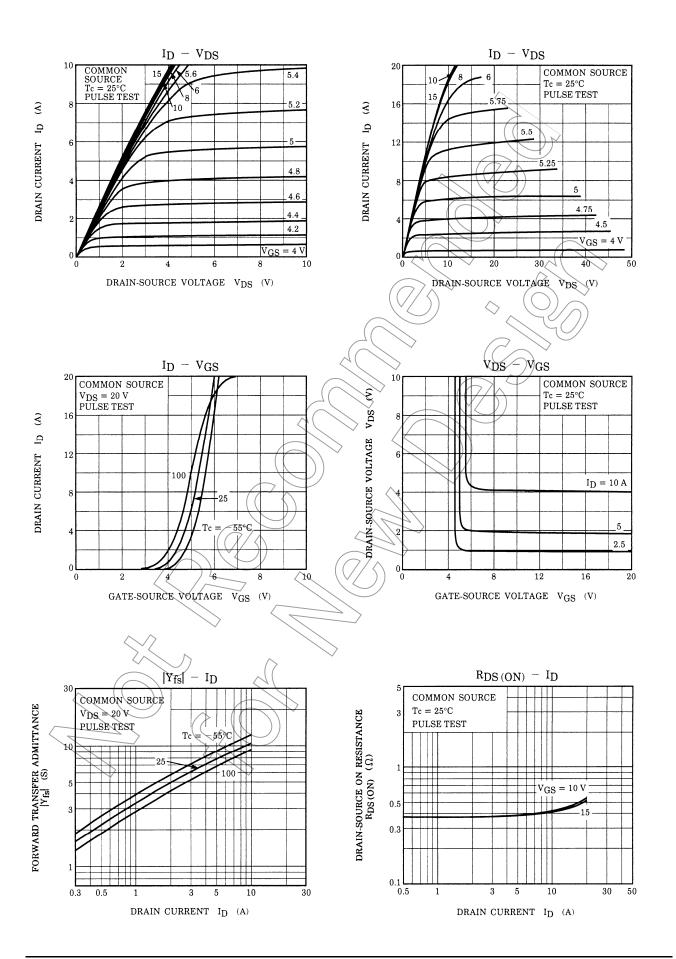
Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

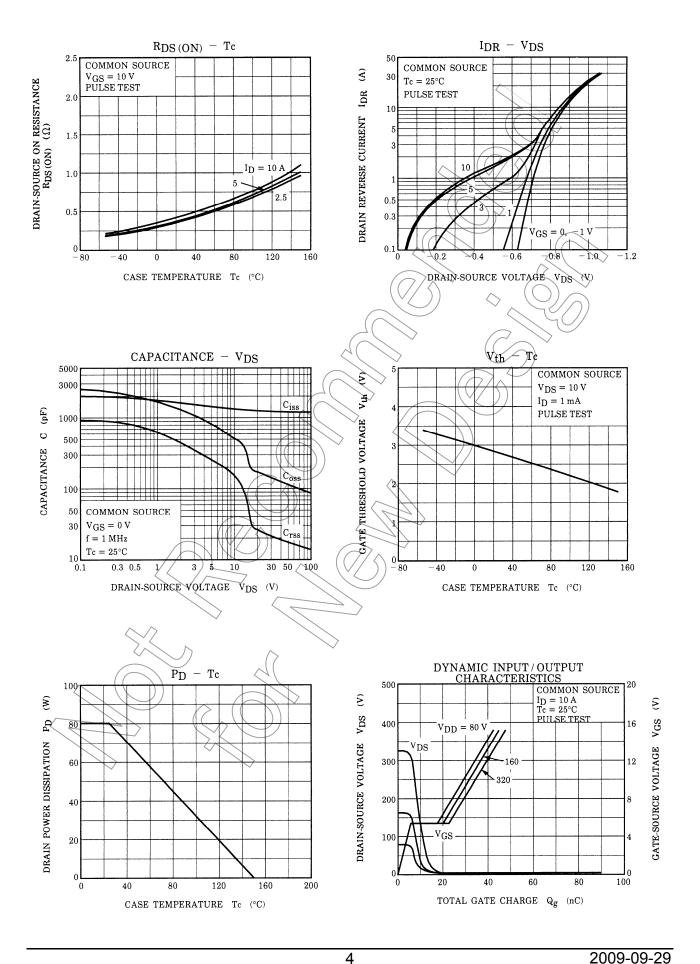
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

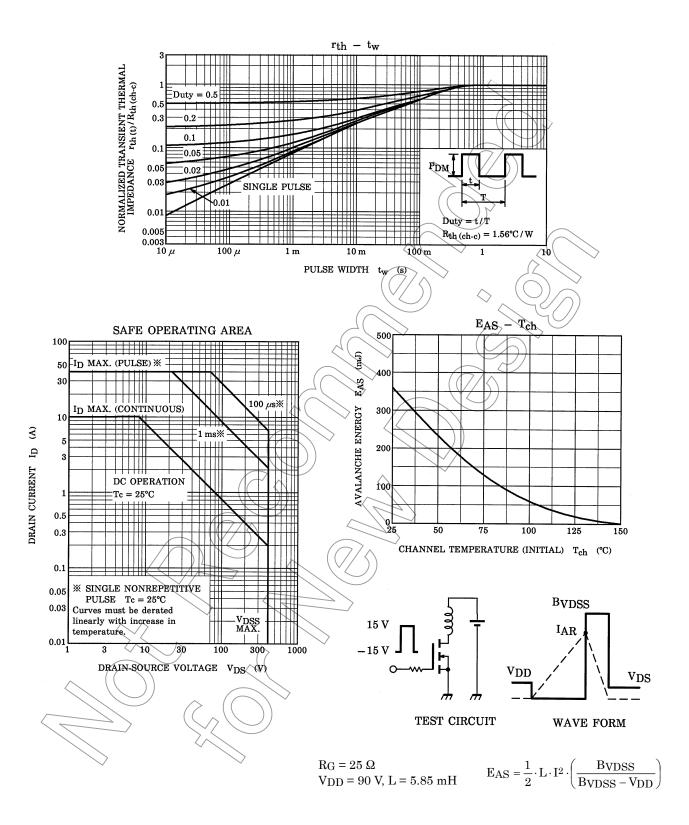
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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